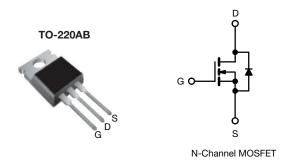
# SiHP085N60EF



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# **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.073				
Q <sub>g</sub> max. (nC)	63					
Q <sub>gs</sub> (nC)	17					
Q <sub>gd</sub> (nC)	9					
Configuration	Single					

## **FEATURES**

- 4<sup>th</sup> generation E series technology
- Low figure of merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free and halogen-free	SiHP085N60EF-T1GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)								
PARAMETER			SYMBOL	LIMIT	UNIT			
Drain-source voltage			V <sub>DS</sub>	600	V			
Gate-source voltage			V <sub>GS</sub>	± 30	V			
Continuous drain current (T <sub>J</sub> = 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	ID	34				
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		21	А			
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	75				
Linear derating factor				1.82	W/°C			
Single pulse avalanche energy b			E <sub>AS</sub>	173	mJ			
Maximum power dissipation			PD	184	W			
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C			
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100	V/ns			
Reverse diode dv/dt <sup>d</sup>		uv/dl	50	v/ns				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.5 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C





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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP. MAX.			UNIT				
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			°C ///				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.55				°C/W			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	600	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.56	-	V/°C	
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 2$	250 µA	3.0	-	5.0	V	
		$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	١	$I_{\rm GS} = \pm 30$	V	-	-	± 1	μA	
Zara gata valtaga drain avreat		V <sub>DS</sub> =	480 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	μA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	2	mA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	ار	<sub>D</sub> = 17 A	-	0.073	0.084	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= 10 V, I <sub>D</sub> =	= 17 A	-	16	-	S	
Dynamic	•					•	•		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 100  KHz		-	2733	-	pF		
Output capacitance	C <sub>oss</sub>			-	100	-			
Reverse transfer capacitance	C <sub>rss</sub>			-	3	-			
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		-	107	-			
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	645	-			
Total gate charge	Qg				-	42	63		
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 17 A, V <sub>DS</sub> = 480 V		-	17	-	nC		
Gate-drain charge	Q <sub>gd</sub>				-	9	-	1	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}$ = 480 V, I <sub>D</sub> = 17 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 9.1 Ω		-	32	64	- ns		
Rise time	t <sub>r</sub>			-	75	113			
Turn-off delay time	t <sub>d(off)</sub>			-	48	96			
Fall time	t <sub>f</sub>			-	53	80			
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	0.7	1.4	Ω		
Drain-Source Body Diode Characteristi		•			•				
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	30	A		
Pulsed diode forward current	I <sub>SM</sub>			-	-	75			
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V		-	-	1.2	V		
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 17 \text{ A},$ di/dt = 100 A/µs, V <sub>B</sub> = 400 V		-	109	218	ns		
Reverse recovery charge					0.6	10	μC		
	Q <sub>rr</sub>	di/dt = 1		$= -400^{1}$	-	0.0	1.2	μΟ	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 400 V

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 400 V



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

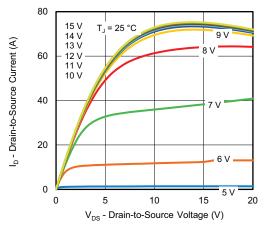


Fig. 1 - Typical Output Characteristics

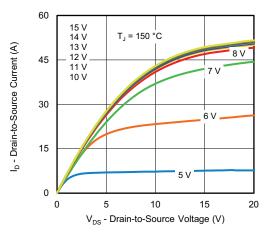


Fig. 2 - Typical Output Characteristics

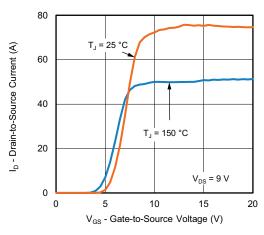


Fig. 3 - Typical Transfer Characteristics

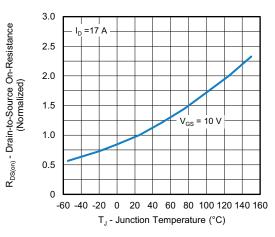


Fig. 4 - Normalized On-Resistance vs. Temperature

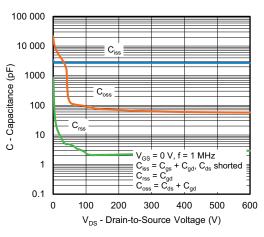
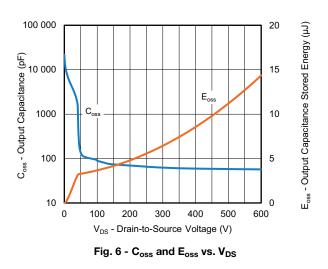


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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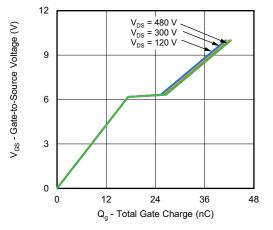


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

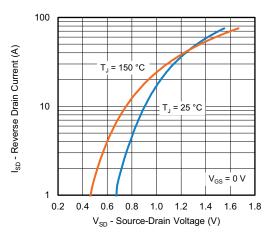


Fig. 8 - Typical Source-Drain Diode Forward Voltage

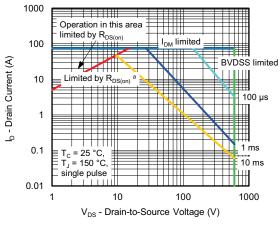


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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(Y) transformed (Y) transfor

Fig. 10 - Maximum Drain Current vs. Case Temperature

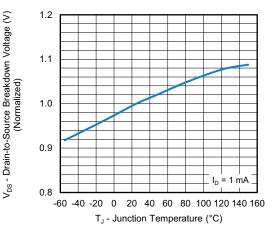
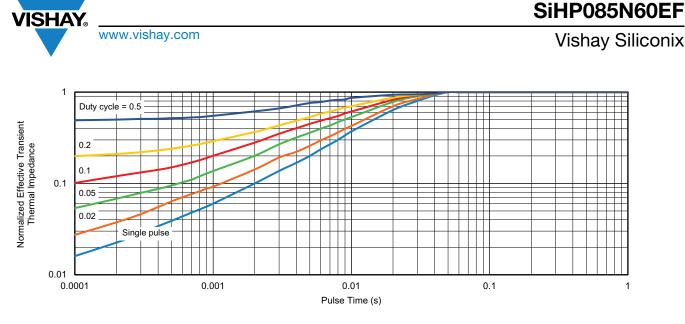
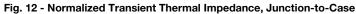


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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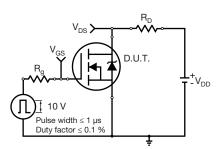


Fig. 13 - Switching Time Test Circuit

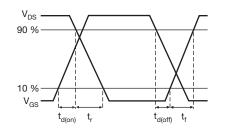


Fig. 14 - Switching Time Waveforms

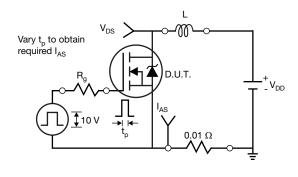


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

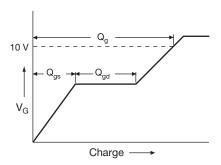
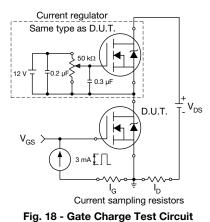


Fig. 17 - Basic Gate Charge Waveform



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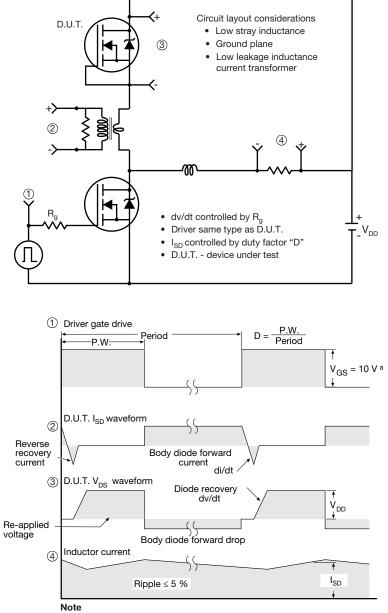
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#### Peak Diode Recovery dv/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

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